# MRS BULLETIN

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ON THE COVER: (Top left) High aspect contact with collimated TiN/Ti liner. Taken from *Applied Physics Letters*. (Top right) Al-Cu reflow for via filling applications. (Bottom left) Cross section of multilevel Al-Cu metallization. (Bottom right) Failure analysis of an integrated circuit chip. Courtesy of Sandia National Laboratories. (Center) Top view of an Al(Cu) metallized stateof-the-art dynamic random access memory chip, courtesy of IBM. Photograph by Tom Way. For more information, see section that begins on page 33.

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